BUW1015

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

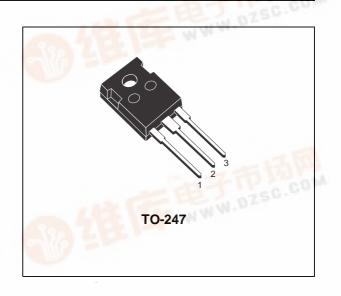
- STMicroelectronics PREFERRED SALESTYPE
- HIGH VOLTAGE CAPABILITY (> 1500 V)
- VERY HIGH SWITCHING SPEED

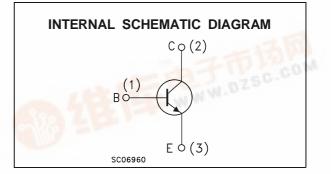
APPLICATIONS:

 HORIZONTAL DEFLECTION FOR HIGH-END COLOUR TV AND 19" MONITORS

DESCRIPTION

The BUW1015 is manufactured using Multiepitaxial Mesa technology for cost-effective high performance and uses a Hollow Emitter structure to enhance switching speeds.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage (I _E = 0)	1500	V
V_{CEO}	Collector-Emitter Voltage (I _B = 0)	700	V
V_{EBO}	Emitter-Base Voltage (I _C = 0)	10	V
Ic	Collector Current	14	Α
Ісм	Collector Peak Current (t _p < 5 ms)	18	А
IB	Base Current	8	А
I _{BM}	Base Peak Current (t _p < 5 ms)	11	А
Ptot	Total Dissipation at $T_c = 25 \ ^{\circ}C$	160	W
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C



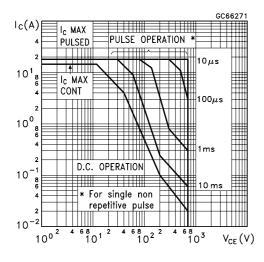
BUW1015

THERMAL DATA

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \,^{\circ}C$ unless otherwise specified)

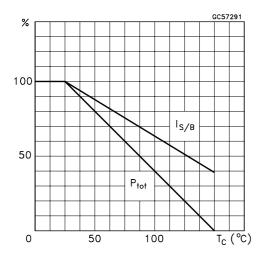
Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit	
ICES	Collector Cut-off Current (V _{BE} = 0)	$V_{CE} = 1500 V$ $V_{CE} = 1500 V$ $T_j = 125 °C$			0.2 2	mA mA	
I _{EBO}	Emitter Cut-off Current $(I_C = 0)$	$V_{EB} = 5 V$			100	μA	
$V_{CEO(sus)^*}$	Collector-Emitter Sustaining Voltage $(I_B = 0)$	I _C = 100 mA	700			V	
V_{EBO}	Emitter-Base Voltage (I _C = 0)	I _E = 10 mA	10			V	
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 10 A I _B = 2 A			1.5	V	
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 10 A I _B = 2 A			1.5	V	
h _{FE} *	DC Current Gain	$ I_C = 10 \ A V_{CE} = 5 \ V \\ I_C = 10 \ A V_{CE} = 5 \ V T_j = 100 \ ^oC $	7 5	10	14		
t _s t _f	RESISTIVE LOAD Storage Time Fall Time	$V_{CC} = 400 V$ $I_C = 10 A$ $I_{B1} = 2 A$ $I_{B2} = -6 A$		1.5 110		μs ns	
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time			4 220		μs ns	
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time	$I_{C} = 6 A \qquad f = 64 \text{ KHz}$ $I_{B1} = 1 A$ $V_{beoff} = -2 V$ $V_{ceflyback} = 1100 \sin\left(\frac{\pi}{5} 10^{6}\right) t V$		3.7 200		μs ns	

* Pulsed: Pulse duration = $300 \,\mu$ s, duty cycle 1.5 %

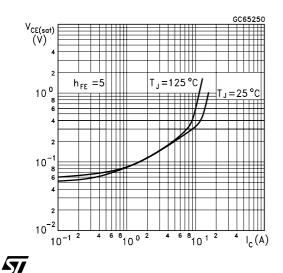


Derating Curve

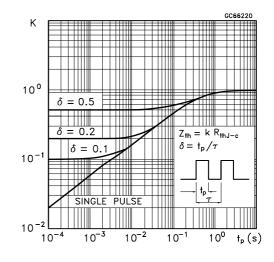
Safe Operating Area



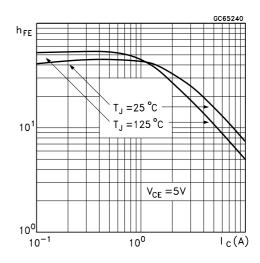
Collector Emitter Saturation Voltage



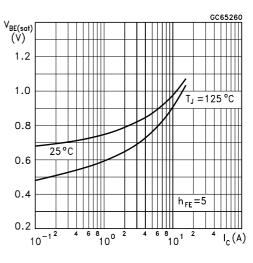
Thermal Impedance

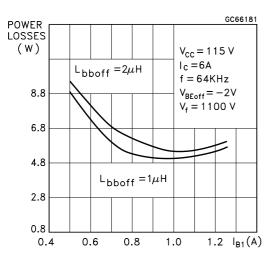


DC Current Gain



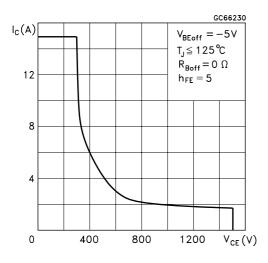
Base Emitter Saturation Voltage





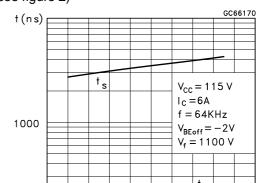
Power Losses at 64 KHz



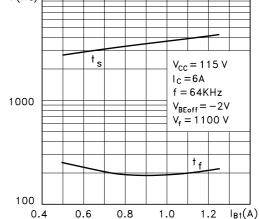




In order to saturate the power switch and reduce conduction losses, adequate direct base current I_{B1} has to be provided for the lowest gain h_{FE} at T_i = 100 °C (line scan phase). On the other hand, negative base current IB2 must be provided the transistor to turn off (retrace phase). Most of the dissipation. especially in the deflection application, occurs at switch-off so it is essential to determine the value of I_{B2} which minimizes power losses, fall time tf and, consequently, Ti. A new set of curves have been defined to give total power losses, t_s and t_f as a function of I_{B1} at 64 KHz scanning frequencies for choosing the



Switching Time Inductive Load at 64KHz (see figure 2)



optimum drive. The test circuit is illustrated in figure 1.

The values of L and C are calculated from the following equations:

$$\frac{1}{2}L(I_{C})^{2} = \frac{1}{2}C(V_{CEfly})^{2}$$
$$\omega = 2\pi f = \frac{1}{\sqrt{LC}}$$

Where I_C= operating collector current, V_{CEfly}= flyback voltage, f= frequency of oscillation during retrace.

<u>ل</u>رکا

Figure 1: Inductive Load Switching Test Circuit.

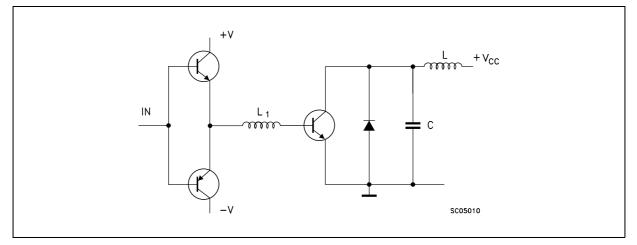
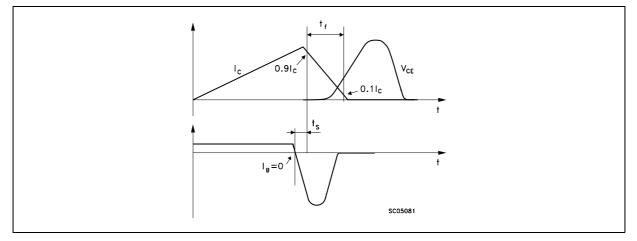


Figure 2: Switching Waveforms in a Deflection Circuit

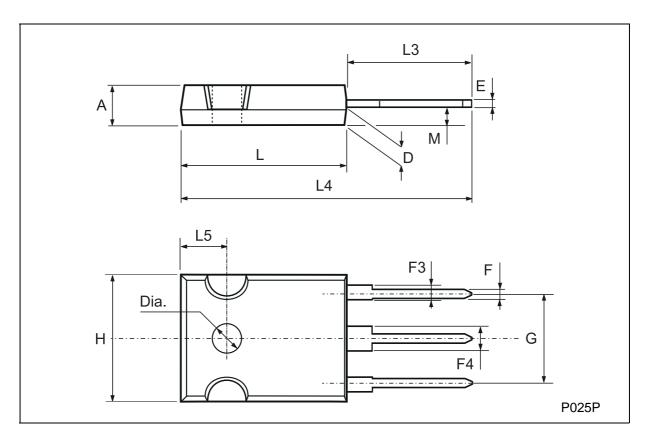
57



BUW1015

DIM.	mm			inch			
DIWI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.7		5.3	0.185		0.209	
D	2.2		2.6	0.087		0.102	
E	0.4		0.8	0.016		0.031	
F	1		1.4	0.039		0.055	
F3	2		2.4	0.079		0.094	
F4	3		3.4	0.118		0.134	
G		10.9			0.429		
Н	15.3		15.9	0.602		0.626	
L	19.7		20.3	0.776		0.779	
L3	14.2		14.8	0.559		0.582	
L4		34.6			1.362		
L5		5.5			0.217		
М	2		3	0.079		0.118	

TO-247 MECHANICAL DATA



57

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specification mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics. The ST logo is a trademark of STMicroelectronics

© 2002 STMicroelectronics - Printed in Italy - All Rights Reserved

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco -Singapore - Spain - Sweden - Switzerland - United Kingdom - United States.

http://www.st.com

